# Mod5 Series 0.50mm Pitch Flip-Top™ BGA Socket



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The new Mod5 Series Flip-Top™
BGA Socket is designed for test,
debug, and validation of 0.50mm pitch
BGA devices. The compact, surface
mount design requires no tooling or
mounting holes in the target PC board,
maximizing real estate while reducing
board costs.

The new Mod5 Series provides a compact, surface mount test solution for micro-BGA chipsets used in applications such as handheld, mobile, and wireless product development.

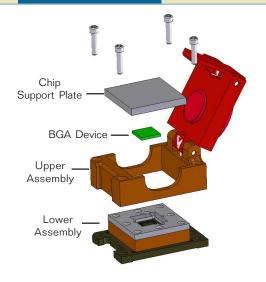
Precision machined spring probes with industry proven solder balls ensure high reliability performance.



#### TYPICAL APPLICATIONS

- Test, validation, and debug of 0.50mm pitch BGA devices
- System and wafer test
- Failure analysis
- Package and chip qualification
- Production prototype

#### How It Works



- ▶ Solder lower assembly to PC board
- Attach **upper assembly** using four supplied screws.
- Insert **BGA device** by hand or with the aid of a vacuum pen (recommended).
- ▶ Place device-specific **chip support plate** (supplied) over device, close lid, and screw down heat sink actuator for device engagement.

#### **Features**

- Model shown accommodates BGA packages up to 12mm sq.
   (22 x 22 rows) larger sizes available upon request
- Precision machined spring probes offer high bandwidth with very low insertion loss
- Compact size (small keepout zone) enables use on existing board layouts
- Flip-Top BGA Socket's easy actuation with simple cover and turn-screw heat sink enables quick insertion and extraction



- SMT design eliminates the cost of hardware and mounting holes and their associated interference with traces on the PCB
- Modular design of lower assembly enables simple reflow process, similar to BGA device
- Metallic probes offer proven reliability over elastomeric sockets and long-life (spring probe contact system life is 200,000 cycles minimum)
- Additional mounting options and custom designs available



5 Energy Way, West Warwick, Rhode Island 02893 USA Tel: 800.424.9850 | 401.823.5200 | Fax: 401.823.8723 E-mail: info@advanced.com | Web: www.advanced.com



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#### Performance

#### Durability

Actuation cycles: 500 minimum

#### **Current Carrying Capacity**

2.8 Amps Max.

#### **Probe Contact Force**

18 g (per position)

#### **Probe Contact Resistance**

80 mOhms

#### Return Loss\*

# Differential Single-Ended -10db @ 2.6 GHz -10db @ 8.0 GHz -15db @ 1.3 GHz -15db @ 3.5 GHz

#### Insertion Loss\*

### Differential

-0.6db @ 2.6 GHz -2.1db @ 8.0 GHz -0.2db @ 1.3 GHz -0.9db @ 3.5 GHz

Single-Ended

\*Complete SI Simulation Report available online

#### Specifications

#### For Device Packages up to 12mm Square

#### **Body Size**

0.79/(20mm) W x 1.06/(27mm) L

#### Height

0.68/(17.4mm)\* approx. (\*will vary based on reflow profile, paste volume, etc.)

#### **Guide Box**

High Temp. Glass Filled Thermoplastic (PPS) Screws: 18-8 Stainless Steel

#### **Base Socket**

FR-4 Glass Epoxy, U.L. Rated 94V-0

#### Lid, Latch, Heat Sink, and Support Plate

Anodized Aluminum

#### **Spring Probe Terminals**

Crown-point Plunger: Tool Steel, Gold Plated Spring: Stainless Steel, Gold Plated Terminal: Brass (C36000), Gold Plated

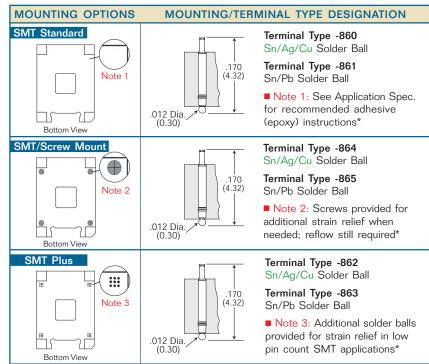
#### Solder Ball (Board Interface)

RoHS Compliant (Lead-free): 96.5Sn/3.0Ag/0.5Cu (SAC305)

Not RoHS (Tin/Lead): 63Sn/37Pb

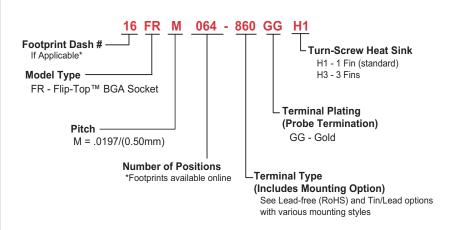
## Continuous Operating Temperature Range -40°C to 140°C (-40°F to 284°F)

#### Table of Models



\*See product Application Specification for complete mounting details.

#### How To Order



- 4-point crown tip spring probes accurately align device solder balls, leaving only minimal witness marks to preserve the solder ball integrity
- Visit www.bgasockets.com to select a footprint or submit your device mechanical specifications to info@advanced.com
- Device mechanical specifications are required prior to ordering to ensure accuracy of device-specific chip support plate
- Sockets are packaged in foam-lined cartons



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